

**SE4606L**

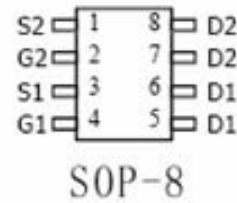
**Complementary Enhancement Mode Field Effect Transistor**

Revision:A

**Features**

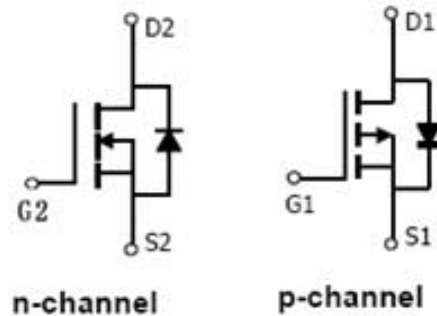
- n-channel,  
 $V_{DS} (V) = 20V$  ,  $I_D = 7A$   
 $R_{DS(ON)} = 20.0m\Omega$  ( $V_{GS} = 4.5V$ )
- p-channel,  
 $V_{DS} (V) = -18V$  ,  $I_D = -5A$   
 $R_{DS(ON)} = 30m\Omega$  ( $V_{GS} = -4.5V$ )

**External Dimensions: (Unit:mm)**



**Applications**

- Power Management in Desktop or DC/DC Converters



**Construction**

- Silicon epitaxial planer

**Absolute maximum ratings (Ta=25°C)**

Parameter	Symbol	Max n-channel	Max P-channel	Unit	
Drain-Source Voltage	$V_{DS}$	20	-18	V	
Gate-Source Voltage	$V_{GSS}$	$\pm 8$	$\pm 8$	V	
Drain Current-Continuous@ Current-Pulsed (Note 1)	$I_D$	$T_A = 25^\circ C$	7.0	-5	A
		$T_A = 70^\circ C$	7.4	-4	A
	$I_{DM}$	50	-30	A	
Maximum Power Dissipation	$P_D$	3	2	W	
Operating Junction and Storage Temperature Range	$T_J, T_{STG}$	-55 To 150	-55 To 150	°C	

**THERMAL CHARACTERISTICS**

Thermal Resistance, Junction-to-Ambient (Note 2)	$R_{\theta JA}$	62.5	62.5	°C/W
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**N-Channel Electrical Characteristics (T<sub>J</sub>=25°C unless otherwise noted)**

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit
OFF CHARACTERISTICS						
Drain-Source Breakdown Voltage	$BV_{DSS}$	$V_{GS} = 0V, I_D = 250\mu A$	20			V

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Zero Gate Voltage Drain Current	$I_{DSS}$	$V_{DS} = 24V, V_{GS} = 0V$			1	$\mu A$
Gate-Body Leakage Current	$I_{GSS}$	$V_{GS} = \pm 20V, V_{DS} = 0V$			$\pm 100$	nA
ON CHARACTERISTICS (Note 3)						
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_D = 250\mu A$		0.65		V
Drain-Source On-State Resistance	$R_{DS(on)}$	$V_{GS} = 4.5V, I_D = 4.5A$		20	23.5	m $\Omega$
		$V_{GS} = 2.5V, I_D = -4.1A$		25	32	m $\Omega$
Forward Transconductance	$g_{FS}$	$V_{DS} = 5V, I_D = 5A$	10	17		S
DYNAMIC CHARACTERISTICS (Note4)						
Input Capacitance	$C_{iss}$	$V_{DS} = 15V, V_{GS} = 0V,$ $F = 1.0MHz$		680		PF
Output Capacitance	$C_{oss}$			102		PF
Reverse Transfer Capacitance	$C_{rss}$			77		PF
SWITCHING CHARACTERISTICS (Note 4)						
Turn-on Delay Time	$t_{d(on)}$	$V_{DS} = 15V, V_{GS} = 10V,$ $R_{GEN} = 3\Omega, R_L = 2.2\Omega$		4.6		nS
Turn-on Rise Time	$t_r$			4.1		nS
Turn-Off Delay Time	$t_{d(off)}$			20.6		nS
Turn-Off Fall Time	$t_f$			5.2		nS
Total Gate Charge	$Q_g$	$V_{DS} = 15V, I_D = 6.9A,$ $V_{GS} = 10V$		13.8		nC
Gate-Source Charge	$Q_{gs}$			1.8		nC
Gate-Drain Charge	$Q_{gd}$			3.3		nC
DRAIN-SOURCE DIODE CHARACTERISTICS						
Diode Forward Voltage (Note 3)	$V_{SD}$	$I_{SD} = 1A$		0.76	1	V
P-Channel Electrical Characteristics (T <sub>J</sub> =25°C unless otherwise noted)						
Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit
OFF CHARACTERISTICS						
Drain-Source Breakdown Voltage	$BV_{DSS}$	$V_{GS} = 0V, I_D = -250\mu A$	-15			V

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Zero Gate Voltage Drain Current	$I_{DSS}$	$V_{DS} = -12V, V_{GS} = 0V$			-1	$\mu A$
Gate-Body Leakage Current	$I_{GSS}$	$V_{GS} = \pm 8V, V_{DS} = 0V$			$\pm 100$	nA
ON CHARACTERISTICS (Note 3)						
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_D = -250\mu A$	.	-0.65		V
Drain-Source On-State Resistance	$R_{DS(on)}$	$V_{GS} = -4.5V, I_D = -4.9A$		31	42	m $\Omega$
		$V_{GS} = -2.5V, I_D = -5A$		36	56	m $\Omega$
Forward Transconductance	$g_{FS}$	$V_{DS} = -12V, I_D = -4.5A$	5	10		S
DYNAMIC CHARACTERISTICS (Note4)						
Turn-on Delay Time	$t_{d(on)}$	$V_{DS} = -12V,$ $V_{GS} = -10V,$ $R_{GEN} = 3\Omega, R_L = 2.7\Omega$		12		nS
Turn-on Rise Time	$t_r$			3		nS
Turn-Off Delay Time	$t_{d(off)}$			22		nS
Turn-Off Fall Time	$t_f$			4		nS
Total Gate Charge	$Q_g$	$V_{DS} = -12V, I_{DS} = -6A,$ $V_{GS} = -10V$		10		nC
Gate-Source Charge	$Q_{gs}$			3.3		nC
Gate-Drain Charge	$Q_{gd}$			1.8		nC
DRAIN-SOURCE DIODE CHARACTERISTICS						
Diode Forward Voltage (Note 3)	$V_{SD}$	$I_{SD} = -1.7A$		-0.8	-1.2	V

N-CHANNEL TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS

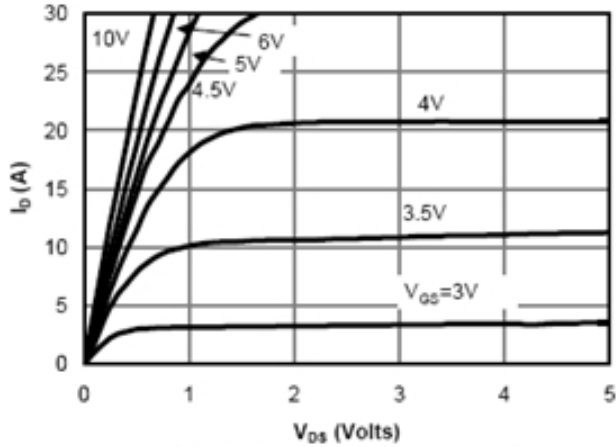


Fig 1: On-Region Characteristics

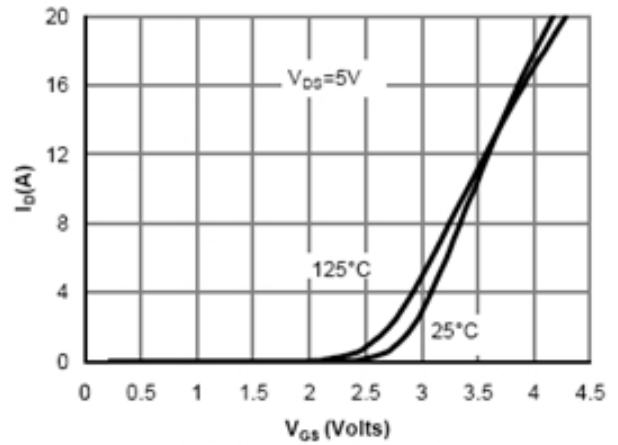


Figure 2: Transfer Characteristics

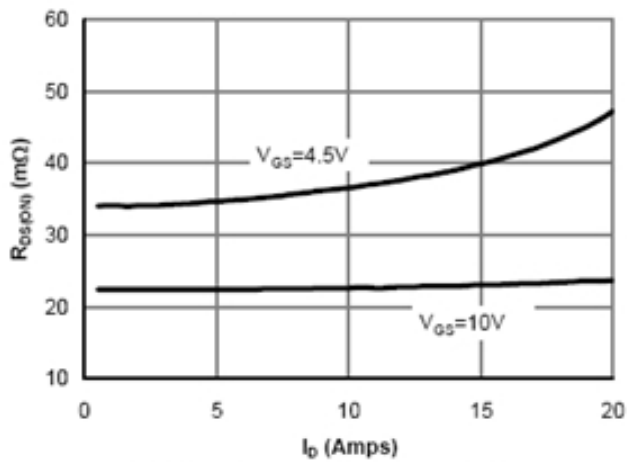


Figure 3: On-Resistance vs. Drain Current and Gate Voltage

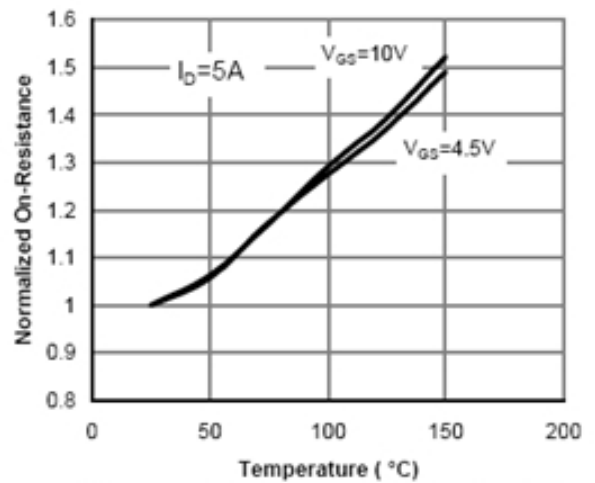


Figure 4: On-Resistance vs. Junction Temperature

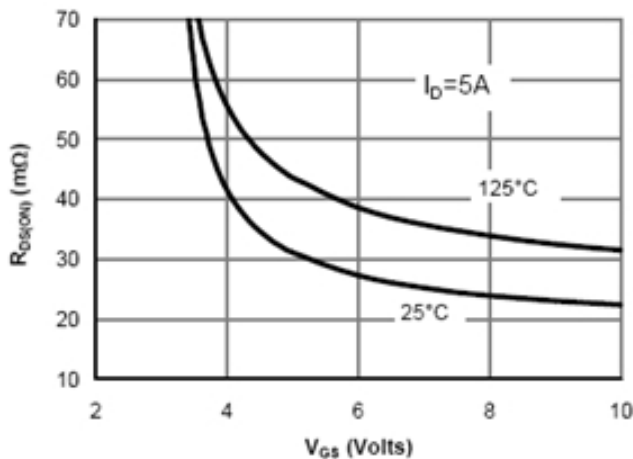


Figure 5: On-Resistance vs. Gate-Source Voltage

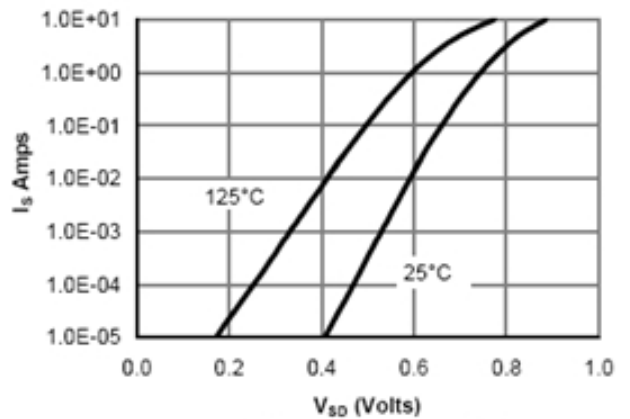


Figure 6: Body diode characteristics

N-CHANNEL TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS

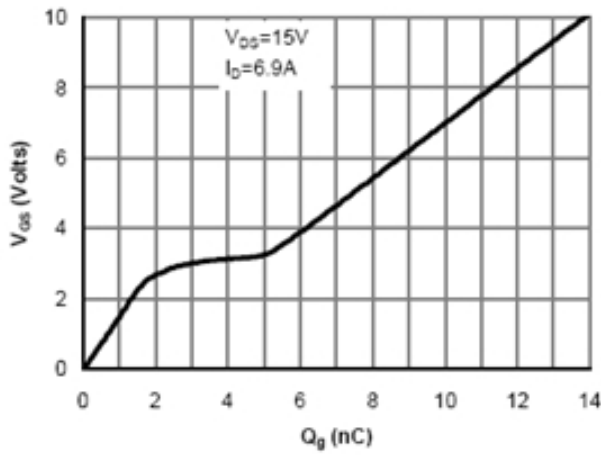


Figure 7: Gate-Charge characteristics

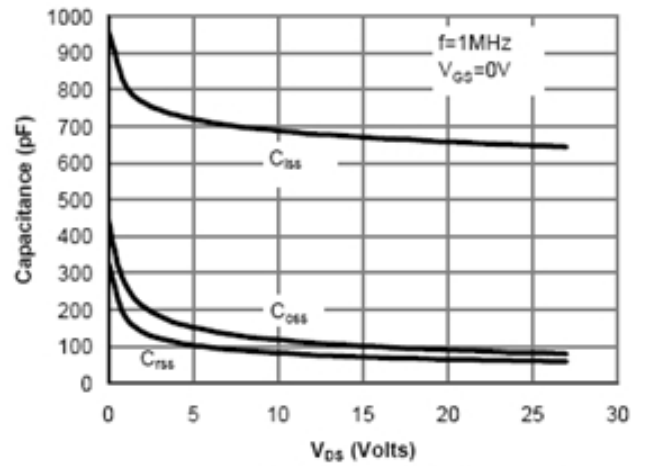


Figure 8: Capacitance Characteristics

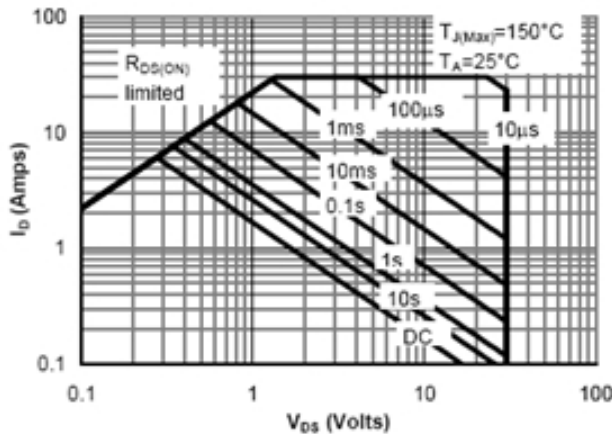


Figure 9: Maximum Forward Biased Safe Operating Area (Note E)

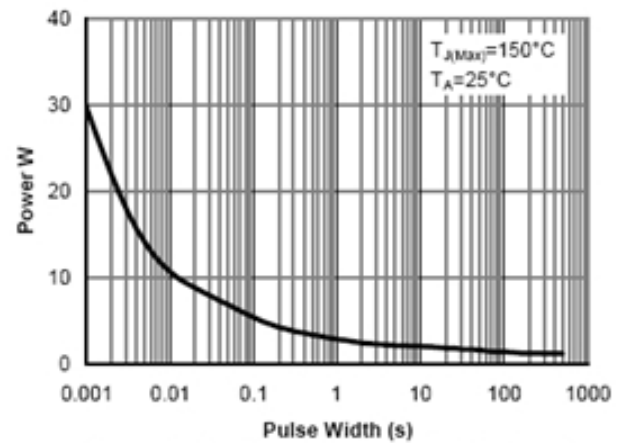


Figure 10: Single Pulse Power Rating Junction-to-Ambient (Note E)

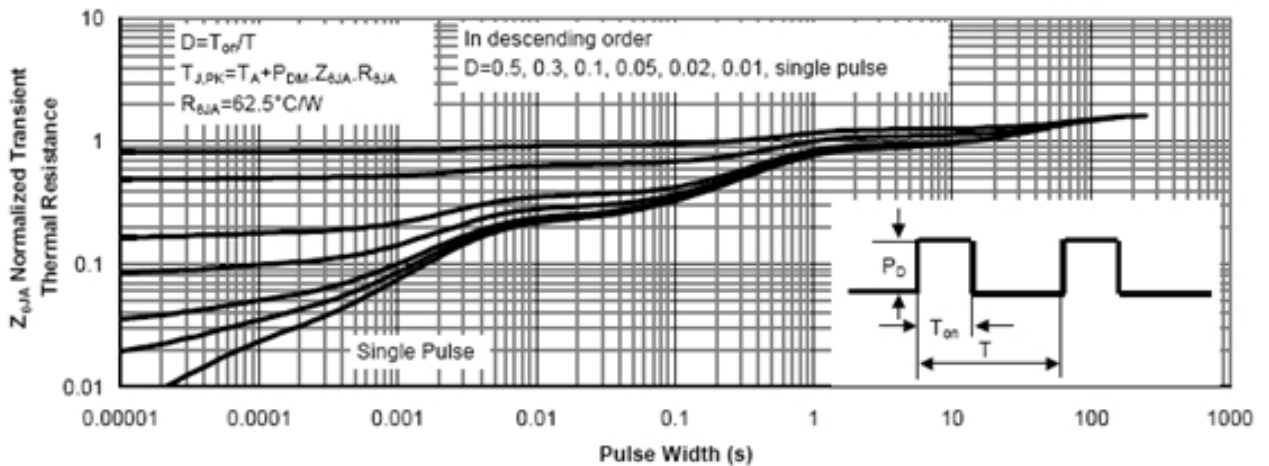


Figure 11: Normalized Maximum Transient Thermal Impedance

P-CHANNEL TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS

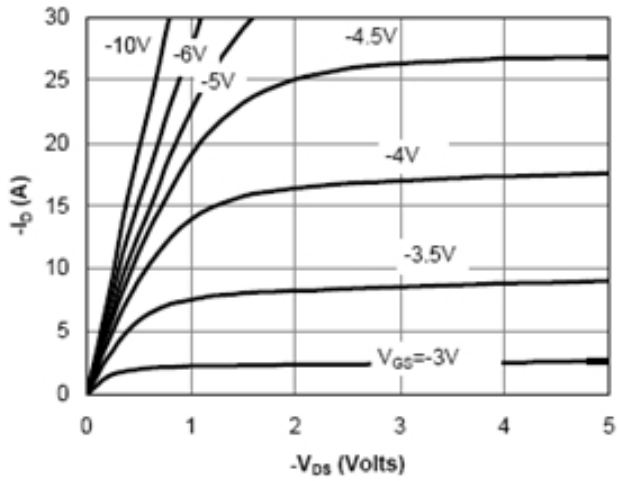


Fig 1: On-Region Characteristics

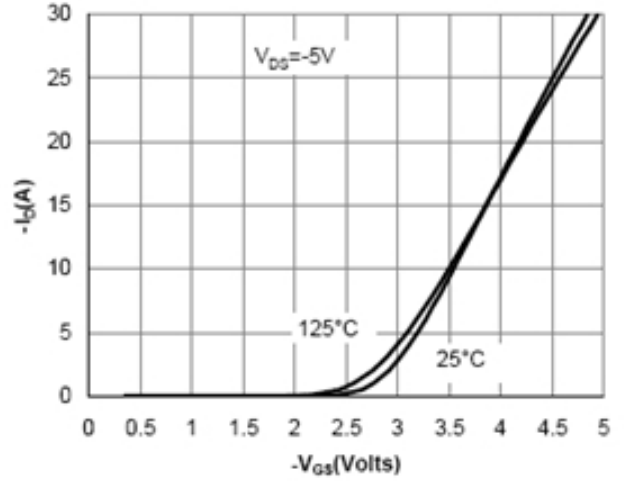


Figure 2: Transfer Characteristics

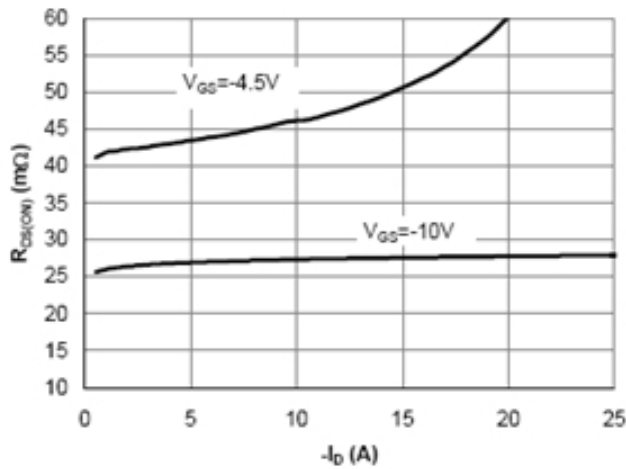


Figure 3: On-Resistance vs. Drain Current and Gate Voltage

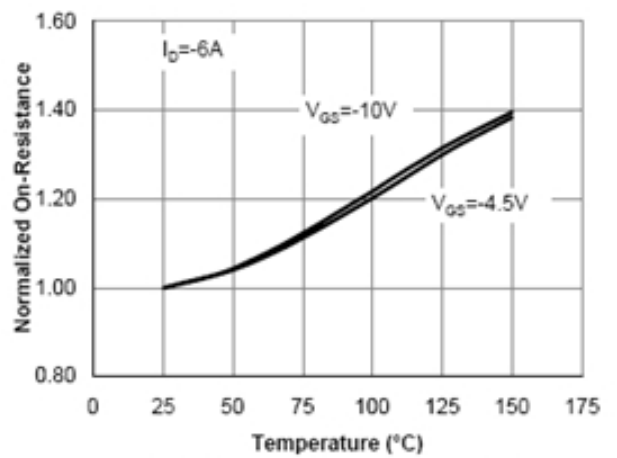


Figure 4: On-Resistance vs. Junction Temperature

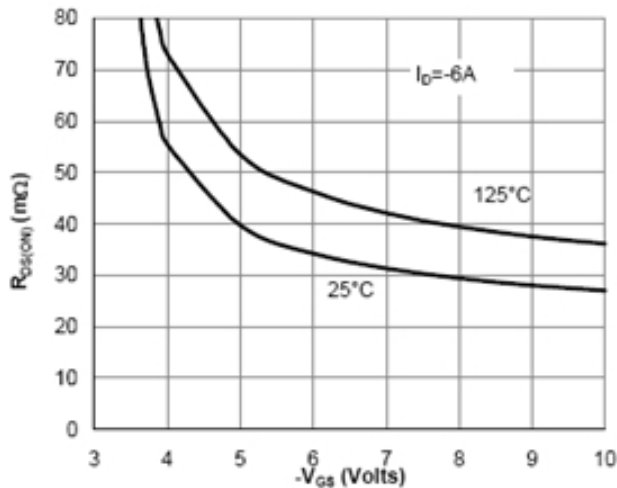


Figure 5: On-Resistance vs. Gate-Source Voltage

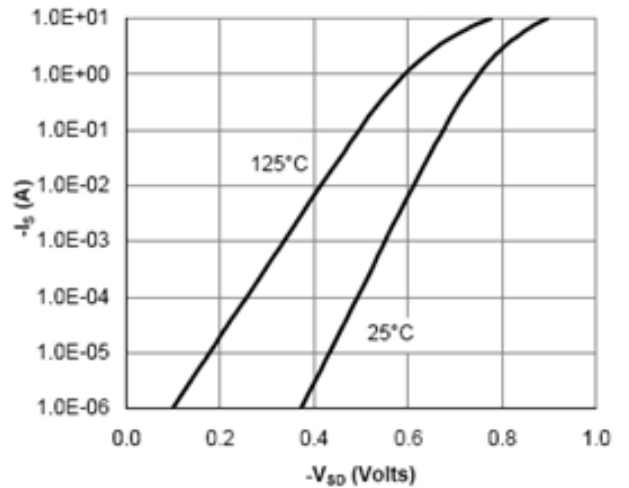


Figure 6: Body-Diode Characteristics

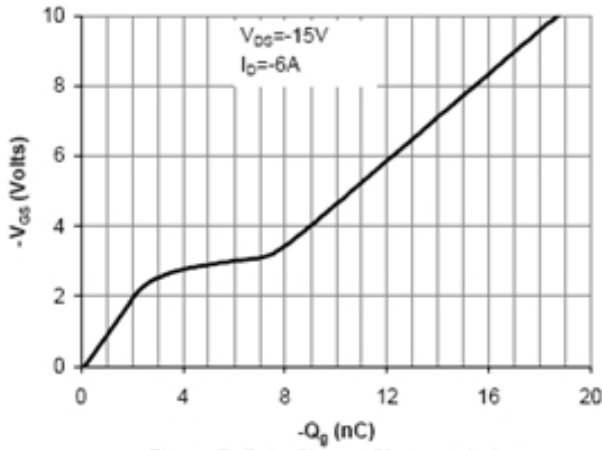


Figure 7: Gate-Charge Characteristics

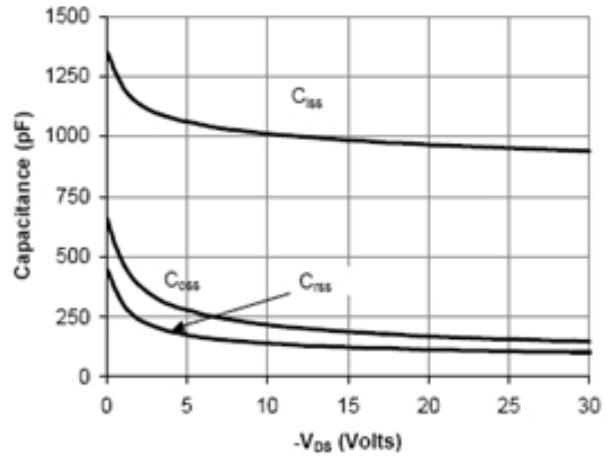


Figure 8: Capacitance Characteristics

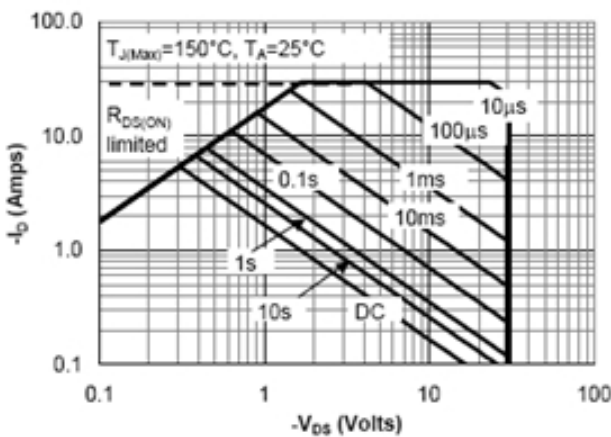


Figure 9: Maximum Forward Biased Safe Operating Area (Note E)

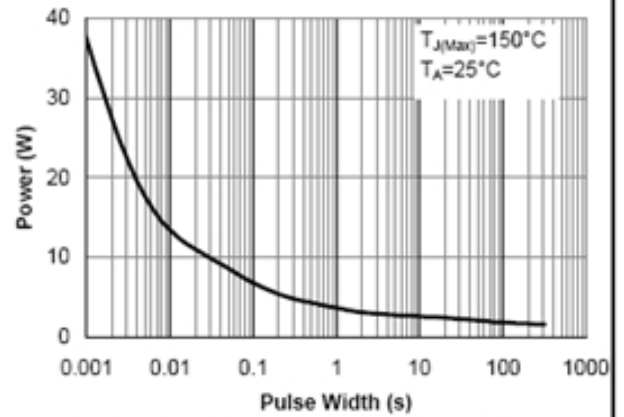


Figure 10: Single Pulse Power Rating Junction-to-Ambient (Note E)

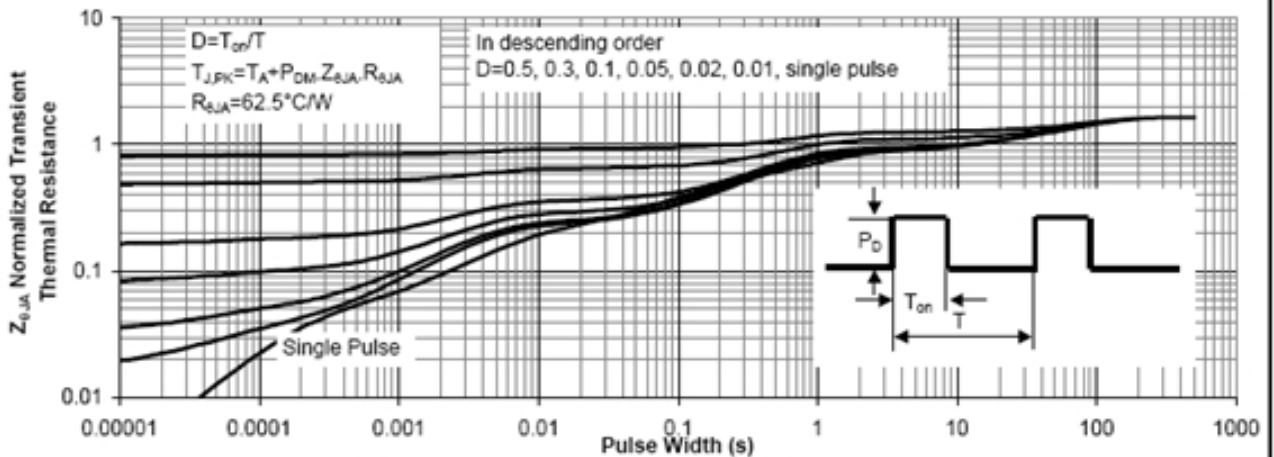
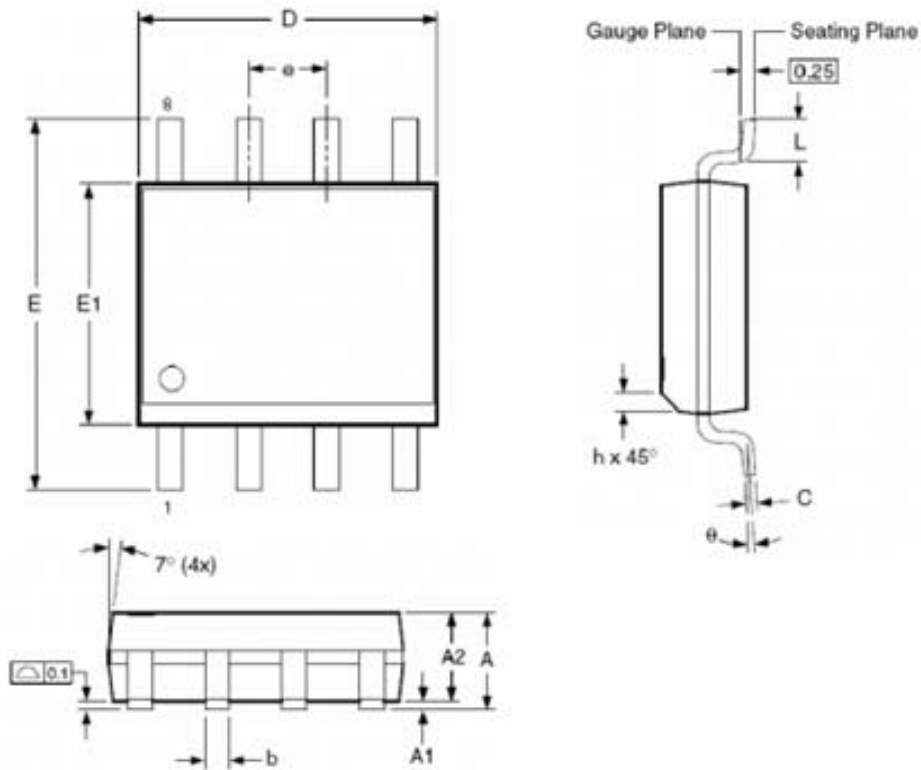


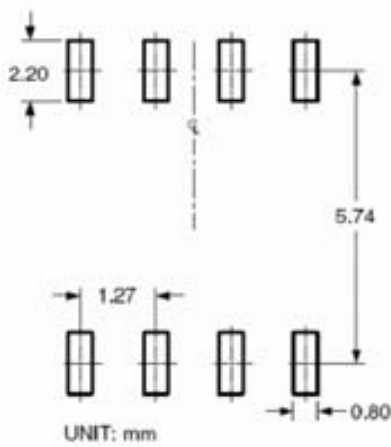
Figure 11: Normalized Maximum Transient Thermal Impedance

# SOP-8 PACKAGE INFORMATION

Dimensions in Millimeters (UNIT:mm)



**RECOMMENDED LAND PATTERN**



**Dimensions in millimeters**

Symbols	Min.	Nom.	Max.
A	1.35	1.65	1.75
A1	0.10	—	0.25
A2	1.25	1.50	1.65
b	0.31	—	0.51
c	0.17	—	0.25
D	4.80	4.90	5.00
E1	3.80	3.90	4.00
e	1.27 BSC		
E	5.80	6.00	6.20
h	0.25	—	0.50
L	0.40	—	1.27
$\theta$	0°	—	8°

**Dimensions in inches**

Symbols	Min.	Nom.	Max.
A	0.053	0.065	0.069
A1	0.004	—	0.010
A2	0.049	0.059	0.065
b	0.012	—	0.020
c	0.007	—	0.010
D	0.189	0.193	0.197
E1	0.150	0.154	0.157
e	0.050 BSC		
E	0.228	0.236	0.244
h	0.010	—	0.020
L	0.016	—	0.050
$\theta$	0°	—	8°

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SHANGHAI SINO-IC MICROELECTRONICS CO., LTD

Add: Building 3, Room 3401-03, No.200 Zhangheng Road, ZhangJiang Hi-Tech Park, Pudong, Shanghai 201203, China

Phone: +86-21-33932402 33932403 33932405 33933508 33933608 Fax:

+86-21-33932401

Email: [szrxw002@126.com](mailto:szrxw002@126.com)

Website: <http://www.sino-ic.net>



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